
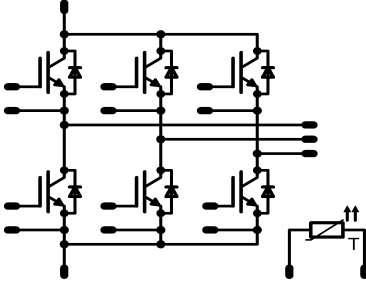




Vincotech

MiniSKiiP® 2 PACK	1200 V / 50 A
<div style="border: 1px solid black; padding: 5px; margin-bottom: 10px;"> <p style="text-align: center; background-color: #00a0e3; color: white; margin: 0;"><b>Features</b></p> <ul style="list-style-type: none"> <li>Solder less interconnection</li> <li>Designed for motor drives up to 15 kW</li> <li>Temperature sensor</li> <li>Standard (6.5mm) and thin (2.8mm) lids, 16mm housing</li> <li>Optional with pre-applied thermal grease</li> </ul> </div> <div style="border: 1px solid black; padding: 5px; margin-bottom: 10px;"> <p style="text-align: center; background-color: #00a0e3; color: white; margin: 0;"><b>Target Applications</b></p> <ul style="list-style-type: none"> <li>Industrial Motor Drives</li> <li>Power Generation</li> <li>UPS</li> </ul> </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #00a0e3; color: white; margin: 0;"><b>Types</b></p> <ul style="list-style-type: none"> <li>V23990-K239-F-PM</li> </ul> </div>	<div style="border: 1px solid black; padding: 5px; margin-bottom: 10px;"> <p style="text-align: center; background-color: #00a0e3; color: white; margin: 0;"><b>MiniSKiiP® 2 housing</b></p>  </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #00a0e3; color: white; margin: 0;"><b>Schematic</b></p>  </div>

### Maximum Ratings

$T_j=25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>T1, T2, T3, T4, T5, T6</b>				
Collector-emitter break down voltage	$V_{CE}$		1200	V
DC collector current	$I_C$	$T_j=T_{j,max}$ $T_n=80^{\circ}\text{C}$	52	A
Repetitive peak collector current	$I_{C,pulse}$	$t_p$ limited by $T_{j,max}$	150	A
Turn off safe operating area		$V_{CE} \leq 1200\text{V}$ , $T_j \leq T_{op,max}$	100	A
Power dissipation	$P_{tot}$	$T_j=T_{j,max}$ $T_n=80^{\circ}\text{C}$	129	W
Gate-emitter peak voltage	$V_{GE}$		20	V
Short circuit ratings	$t_{SC}$	$T_j \leq 150^{\circ}\text{C}$	10	$\mu\text{s}$
	$V_{CC}$	$V_{GE}=15\text{V}$	600	V
Maximum Junction Temperature	$T_{j,max}$		150	$^{\circ}\text{C}$
<b>D1, D2, D3, D4, D5, D6</b>				
Peak Repetitive Reverse Voltage	$V_{RRM}$		1200	V
DC forward current	$I_F$	$T_j=T_{j,max}$ $T_n=80^{\circ}\text{C}$	34	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{j,max}$	67	A
Power dissipation	$P_{tot}$	$T_j=T_{j,max}$ $T_n=80^{\circ}\text{C}$	66	W
Maximum Junction Temperature	$T_{j,max}$		150	$^{\circ}\text{C}$



### Maximum Ratings

T<sub>J</sub>=25°C, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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#### Thermal Properties

Storage temperature	T <sub>stg</sub>		-40...+125	°C
Operation temperature under switching condition	T <sub>op</sub>		-40...+125	°C

#### Insulation Properties

Insulation voltage	V <sub>is</sub>	t=2s DC voltage	4000	V
Creepage distance			min 12,7	mm
Clearance			min 12,7	mm
Stage	CTI		>200	

**Characteristic Values**

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V] or $V_{GS}$ [V]	$V_r$ [V] or $V_{CE}$ [V] or $V_{DS}$ [V]	$I_c$ [A] or $I_F$ [A] or $I_b$ [A]	$T_j$	Min	Typ	Max		
<b>T1,T2,T3,T4,T5,T6</b>										
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,001	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		50	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	1,35	1,67 1,89	2,1	V
Collector-emitter cut-off current incl. Diode	$I_{CES}$		0	1200		$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		0,25 2,5		mA
Gate-emitter leakage current	$I_{GES}$		20	0		$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		600		nA
Integrated Gate resistor	$R_{gint}$							4		$\Omega$
Turn-on delay time	$t_{d(on)}$	$R_{goff}=18\ \Omega$ $R_{gon}=18\ \Omega$	$\pm 15$	600	50	$T_j=25^\circ\text{C}$				ns
Rise time	$t_r$					$T_j=125^\circ\text{C}$				
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ\text{C}$				
Fall time	$t_f$					$T_j=125^\circ\text{C}$				
Turn-on energy loss per pulse	$E_{on}$					$T_j=25^\circ\text{C}$				
Turn-off energy loss per pulse	$E_{off}$					$T_j=125^\circ\text{C}$				
Input capacitance	$C_{ies}$	f=1MHz	0	25		$T_j=25^\circ\text{C}$		3720		pF
Output capacitance	$C_{oss}$									
Reverse transfer capacitance	$C_{rss}$									
Gate charge	$Q_{Gate}$		$\pm 15$	960	50	$T_j=25^\circ\text{C}$		310		nC
Thermal resistance chip to heatsink	$R_{thJH}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 1\ \text{W/mK}$						0,55		K/W
<b>D1,D2,D3,D4,D5,D6</b>										
Diode forward voltage	$V_F$				45	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		1,51 1,53	1,77	V
Peak reverse recovery current	$I_{RRM}$	$R_{goff}=18\ \Omega$	$\pm 15$	600	50	$T_j=25^\circ\text{C}$				A
Reverse recovery time	$t_{rr}$					$T_j=125^\circ\text{C}$				
Reverse recovered charge	$Q_{rr}$					$T_j=25^\circ\text{C}$				
Peak rate of fall of recovery current	$di(\text{rec})_{\text{max}}/dt$					$T_j=125^\circ\text{C}$				
Reverse recovered energy	$E_{rec}$					$T_j=25^\circ\text{C}$				
						$T_j=125^\circ\text{C}$				
Thermal resistance chip to heatsink	$R_{thJH}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 1\ \text{W/mK}$						1		K/W
<b>Thermistor</b>										
Rated resistance	R					$T_j=25^\circ\text{C}$		1000		$\Omega$
Deviation of R100	$\Delta R/R$	R100=1670 $\Omega$				$T_c=100^\circ\text{C}$	-3		3	%
R100	$R_{100}$					$T_c=100^\circ\text{C}$		1670		$\Omega$
A-value	$B_{(25/50)}$					$T_j=25^\circ\text{C}$		$7,635 \cdot 10^{-3}$		1/K
B-value	$B_{(25/100)}$					$T_j=25^\circ\text{C}$		$1,731 \cdot 10^{-5}$		1/K <sup>2</sup>
Vincotech NTC Reference						$T_j=25^\circ\text{C}$			E	

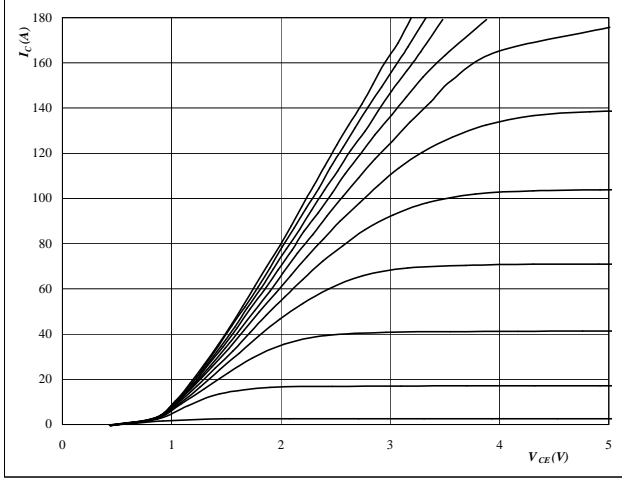


### T1,T2,T3,T4,T5,T6 / D1,D2,D3,D4,D5,D6

Figure 1 T1,T2,T3,T4,T5,T6 IGBT

Typical output characteristics

$I_C = f(V_{CE})$

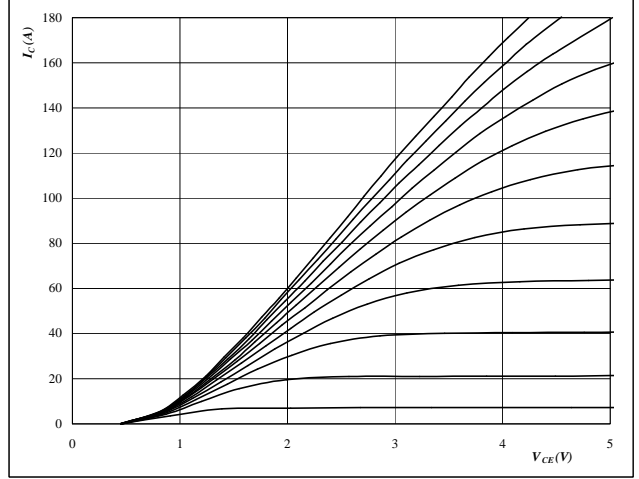


At  
 $t_p = 250 \mu s$   
 $T_j = 25 \text{ }^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

Figure 2 T1,T2,T3,T4,T5,T6 IGBT

Typical output characteristics

$I_C = f(V_{CE})$

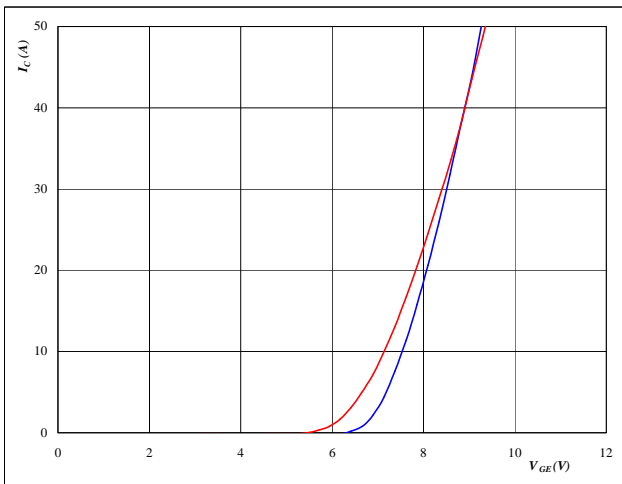


At  
 $t_p = 250 \mu s$   
 $T_j = 125 \text{ }^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

Figure 3 T1,T2,T3,T4,T5,T6 IGBT

Typical transfer characteristics

$I_C = f(V_{GE})$

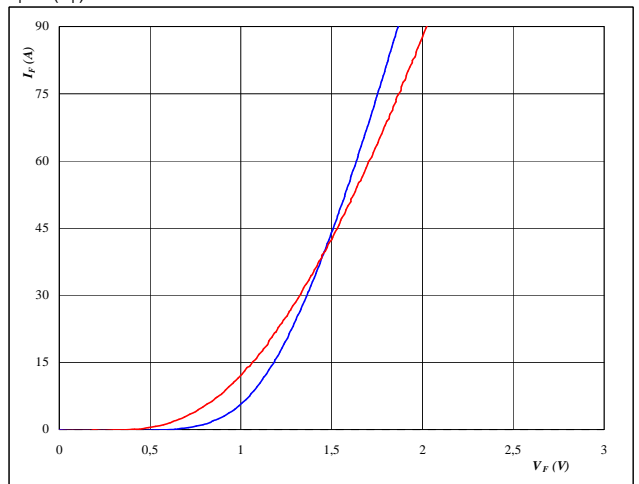


At  
 $T_j = 25/125 \text{ }^\circ C$   
 $t_p = 250 \mu s$   
 $V_{CE} = 10 \text{ V}$

Figure 4 D1,D2,D3,D4,D5,D6 FWD

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



At  
 $t_p = 250 \mu s$

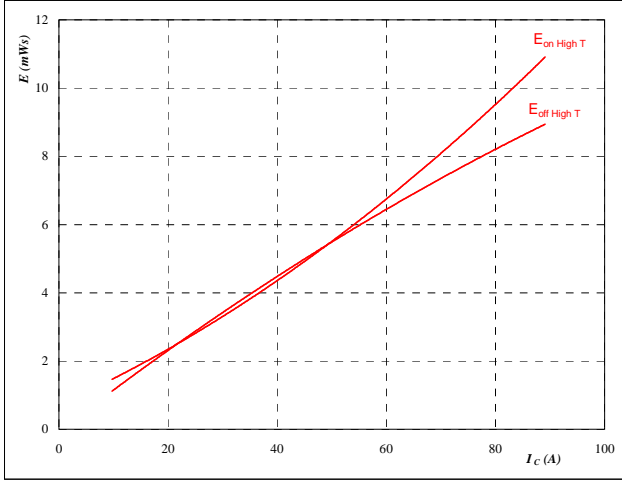


T1,T2,T3,T4,T5,T6/D1,D2,D3,D4,D5,D6

Figure 5 T1,T2,T3,T4,T5,T6 IGBT

Typical switching energy losses  
as a function of collector current

$E = f(I_C)$



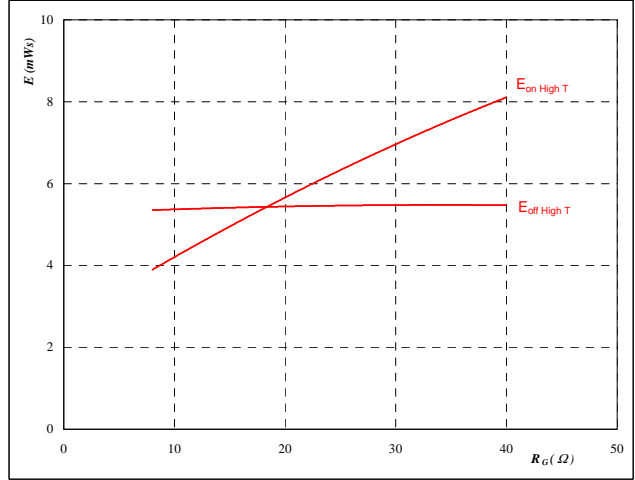
With an inductive load at

$T_J =$	125	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	18	Ω
$R_{goff} =$	18	Ω

Figure 6 T1,T2,T3,T4,T5,T6 IGBT

Typical switching energy losses  
as a function of gate resistor

$E = f(R_G)$



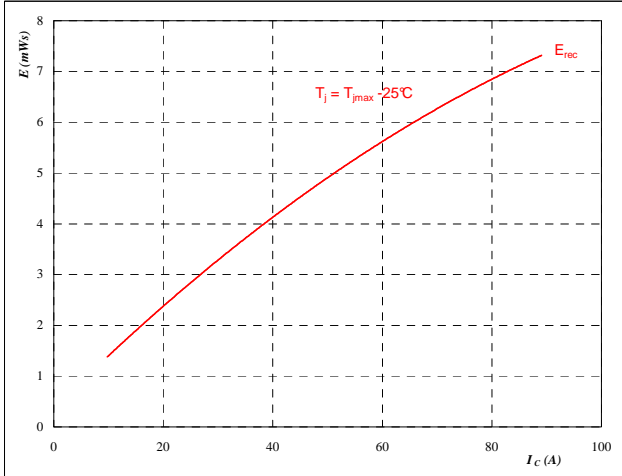
With an inductive load at

$T_J =$	125	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	50	A

Figure 7 D1,D2,D3,D4,D5,D6 FWD

Typical reverse recovery energy loss  
as a function of collector current

$E_{rec} = f(I_C)$



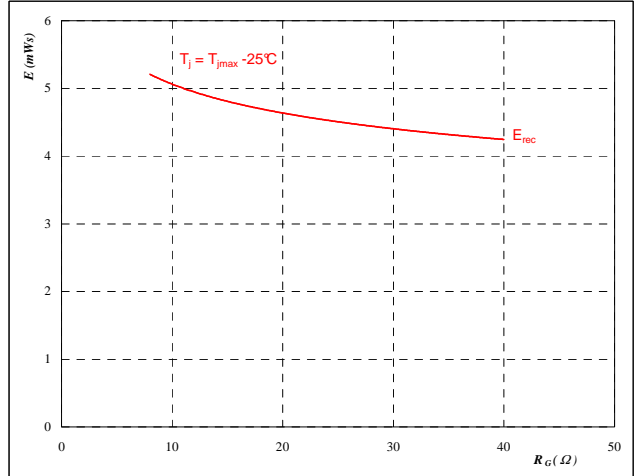
With an inductive load at

$T_J =$	125	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	18	Ω

Figure 8 D1,D2,D3,D4,D5,D6 FWD

Typical reverse recovery energy loss  
as a function of gate resistor

$E_{rec} = f(R_G)$



With an inductive load at

$T_J =$	125	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	50	A

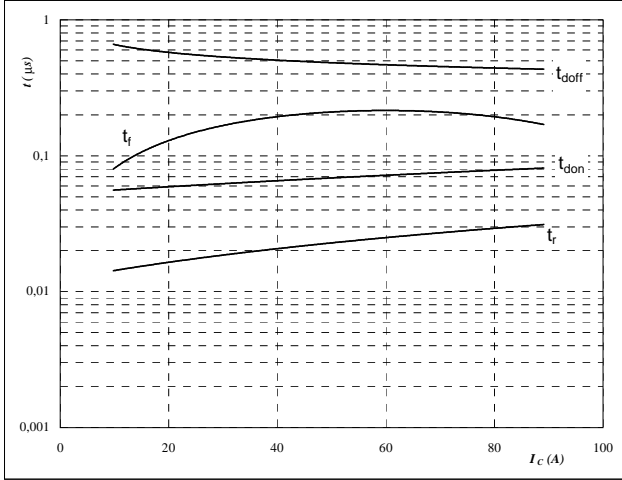


T1,T2,T3,T4,T5,T6/D1,D2,D3,D4,D5,D6

Figure 9 T1,T2,T3,T4,T5,T6 IGBT

Typical switching times as a function of collector current

$t = f(I_C)$



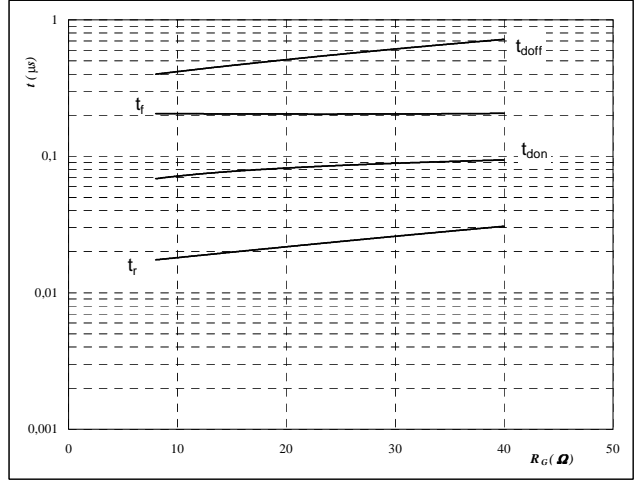
With an inductive load at

$T_j =$	125	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	18	Ω
$R_{goff} =$	18	Ω

Figure 10 T1,T2,T3,T4,T5,T6 IGBT

Typical switching times as a function of gate resistor

$t = f(R_G)$



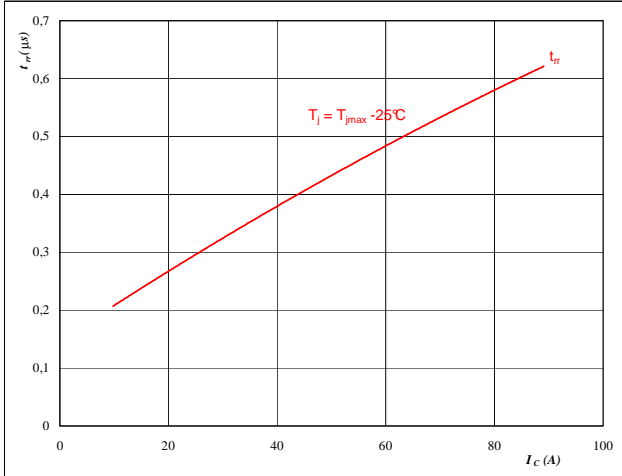
With an inductive load at

$T_j =$	125	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	50	A

Figure 11 D1,D2,D3,D4,D5,D6 FWD

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$



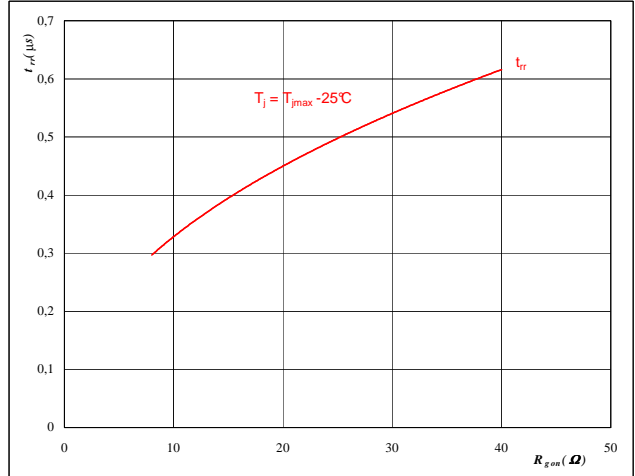
At

$T_j =$	125	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	18	Ω

Figure 12 D1,D2,D3,D4,D5,D6 FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$t_{rr} = f(R_{gon})$



At

$T_j =$	125	°C
$V_R =$	600	V
$I_F =$	50	A
$V_{GE} =$	±15	V

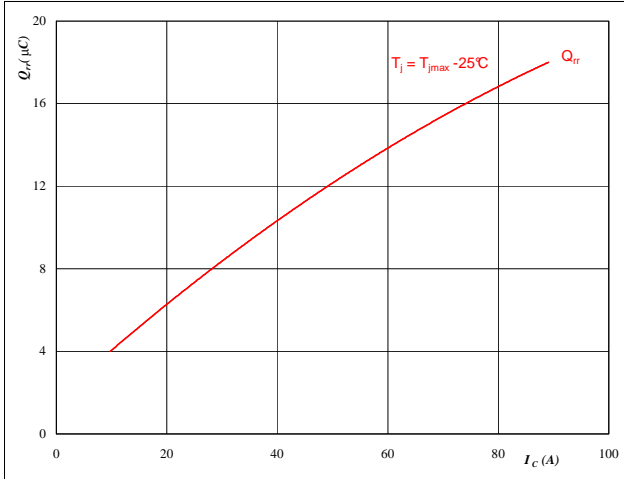


### T1,T2,T3,T4,T5,T6 / D1,D2,D3,D4,D5,D6

Figure 13 D1,D2,D3,D4,D5,D6 FWD

Typical reverse recovery charge as a function of collector current

$Q_{rr} = f(I_C)$

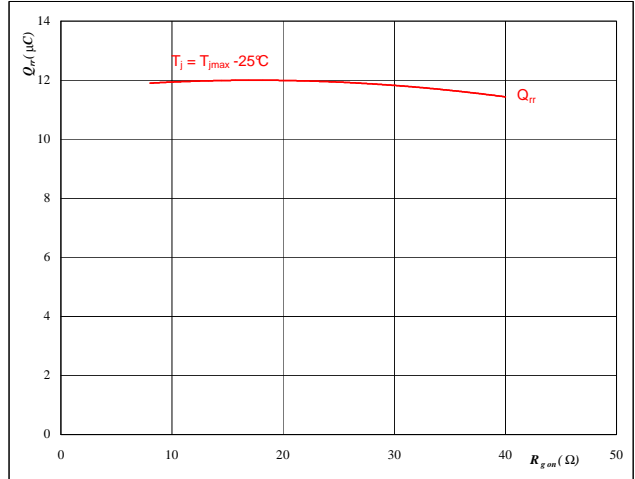


At  
 $T_j = 125$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 18$  Ω

Figure 14 D1,D2,D3,D4,D5,D6 FWD

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$Q_{rr} = f(R_{gon})$

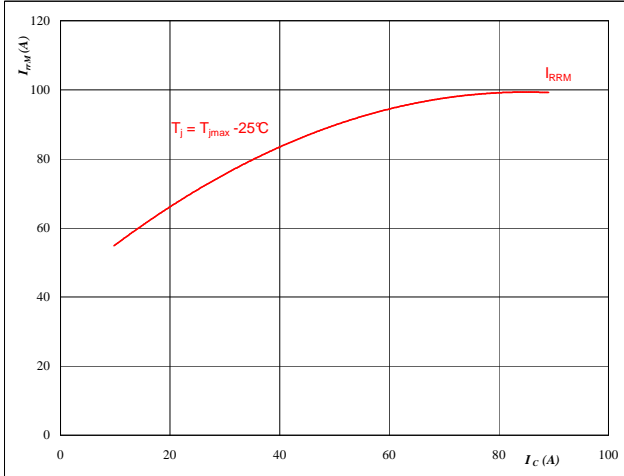


At  
 $T_j = 125$  °C  
 $V_R = 600$  V  
 $I_F = 50$  A  
 $V_{GE} = \pm 15$  V

Figure 15 D1,D2,D3,D4,D5,D6 FWD

Typical reverse recovery current as a function of collector current

$I_{RRM} = f(I_C)$

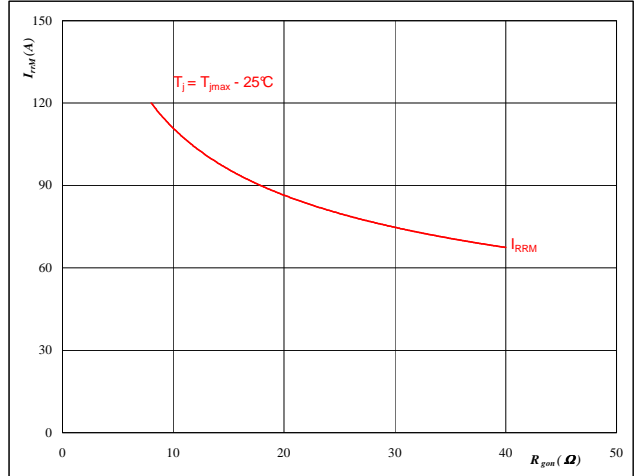


At  
 $T_j = 125$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 18$  Ω

Figure 16 D1,D2,D3,D4,D5,D6 FWD

Typical reverse recovery current as a function of IGBT turn on gate resistor

$I_{RRM} = f(R_{gon})$



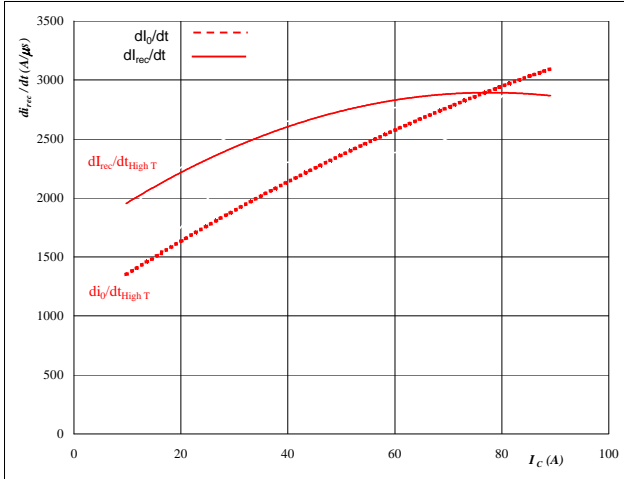
At  
 $T_j = 125$  °C  
 $V_R = 600$  V  
 $I_F = 50$  A  
 $V_{GE} = \pm 15$  V



T1,T2,T3,T4,T5,T6 / D1,D2,D3,D4,D5,D6

Figure 17 D1,D2,D3,D4,D5,D6 FWD

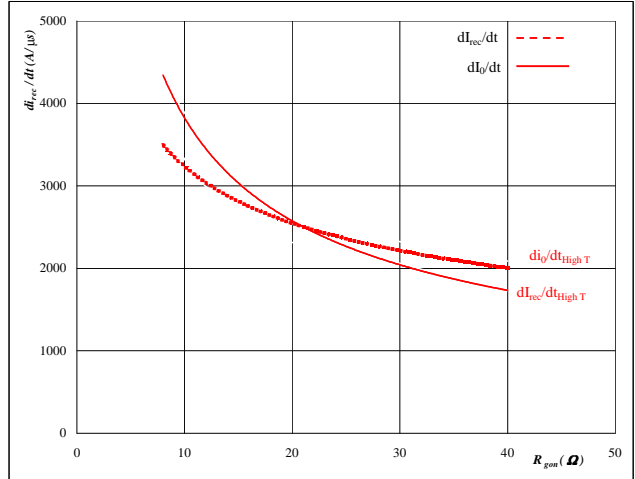
Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $dI_F/dt, dI_{rec}/dt = f(I_C)$



At  
 $T_j = 125 \text{ } ^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 18 \text{ } \Omega$

Figure 18 D1,D2,D3,D4,D5,D6 FWD

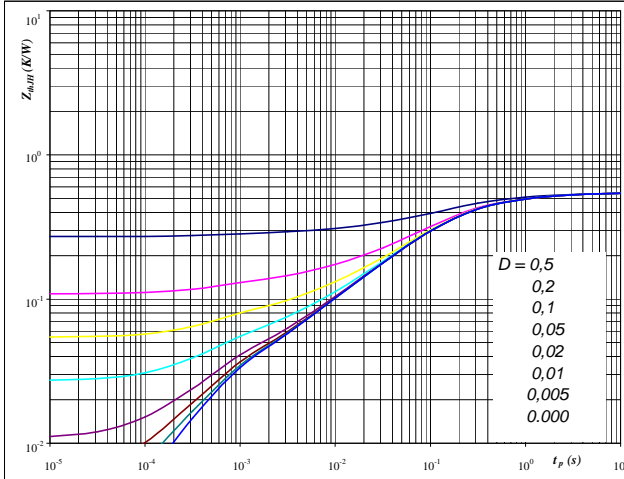
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor  
 $dI_F/dt, dI_{rec}/dt = f(R_{gon})$



At  
 $T_j = 125 \text{ } ^\circ\text{C}$   
 $V_R = 600 \text{ V}$   
 $I_F = 50 \text{ A}$   
 $V_{GE} = \pm 15 \text{ V}$

Figure 19 T1,T2,T3,T4,T5,T6 IGBT

IGBT transient thermal impedance as a function of pulse width  
 $Z_{thJH} = f(t_p)$



At  
 $D = t_p / T$   
 $R_{thJH} = 0,54 \text{ K/W}$

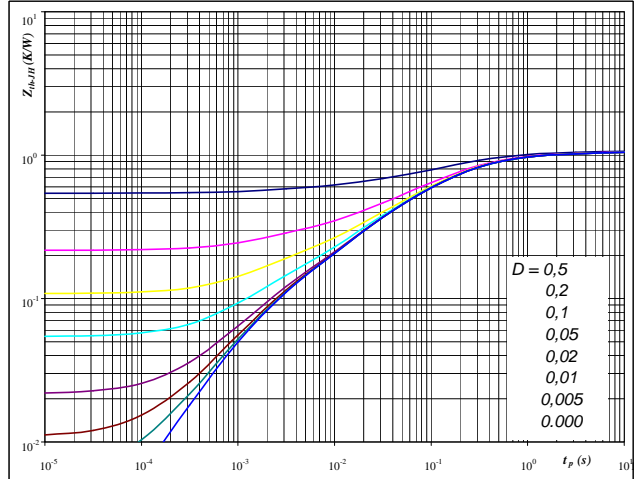
IGBT thermal model values

Thermal grease

R (K/W)	Tau (s)
0,08	1,8E+00
0,22	2,2E-01
0,16	6,3E-02
0,06	8,4E-03
0,03	6,2E-04

Figure 20 D1,D2,D3,D4,D5,D6 FWD

FWD transient thermal impedance as a function of pulse width  
 $Z_{thJH} = f(t_p)$



At  
 $D = t_p / T$   
 $R_{thJH} = 1,06 \text{ K/W}$

FWD thermal model values

Thermal grease

R (K/W)	Tau (s)
0,05	3,4E+01
0,08	2,2E+00
0,33	3,4E-01
0,39	8,5E-02
0,16	1,5E-02
0,07	1,6E-03



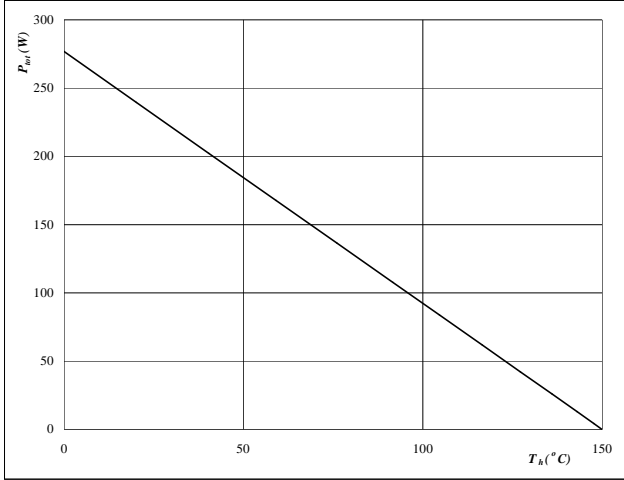


### T1,T2,T3,T4,T5,T6 / D1,D2,D3,D4,D5,D6

Figure 21 T1,T2,T3,T4,T5,T6 IGBT

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

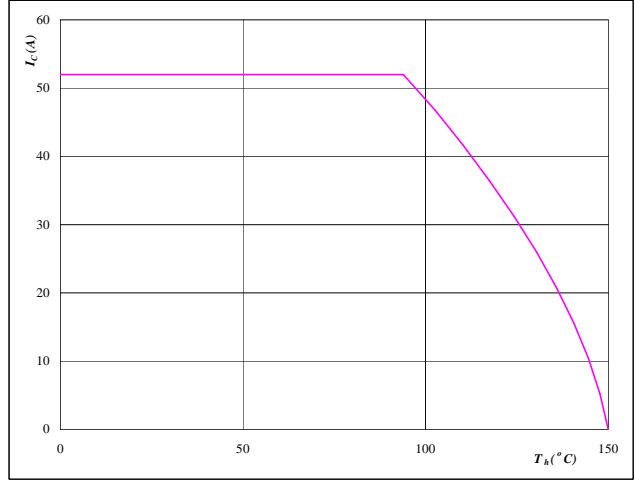


At  
 $T_j = 150$  °C

Figure 22 T1,T2,T3,T4,T5,T6 IGBT

Collector current as a function of heatsink temperature

$I_C = f(T_h)$

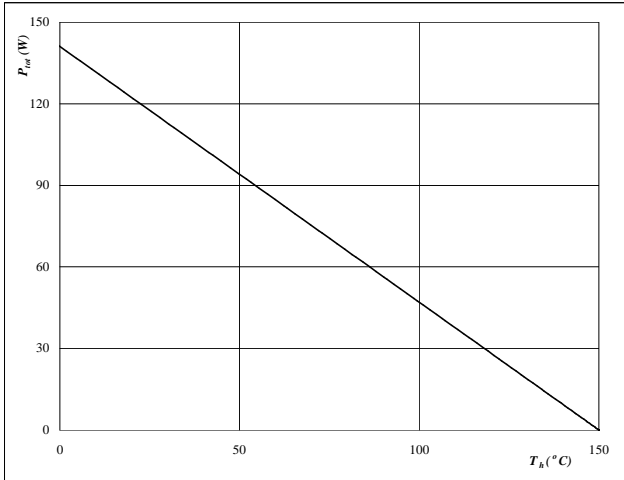


At  
 $T_j = 150$  °C  
 $V_{GE} = 15$  V

Figure 23 D1,D2,D3,D4,D5,D6 FWD

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

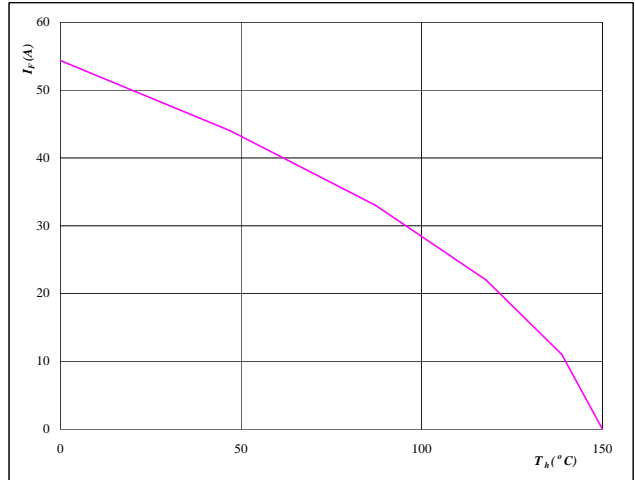


At  
 $T_j = 150$  °C

Figure 24 D1,D2,D3,D4,D5,D6 FWD

Forward current as a function of heatsink temperature

$I_F = f(T_h)$



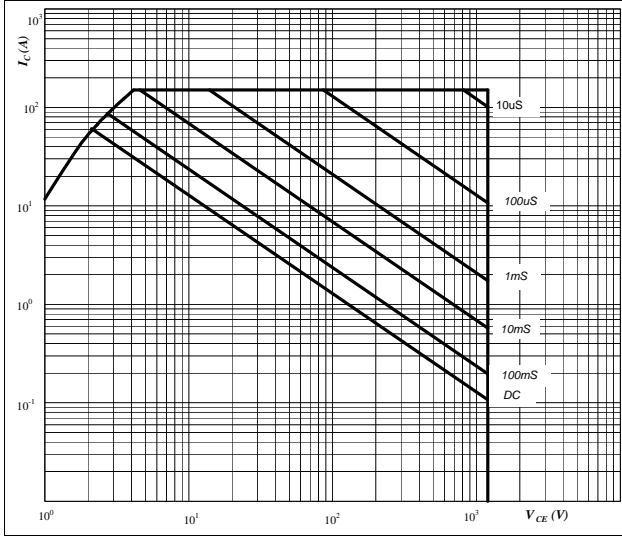
At  
 $T_j = 150$  °C



T1,T2,T3,T4,T5,T6 / D1,D2,D3,D4,D5,D6

Figure 25 T1,T2,T3,T4,T5,T6 IGBT

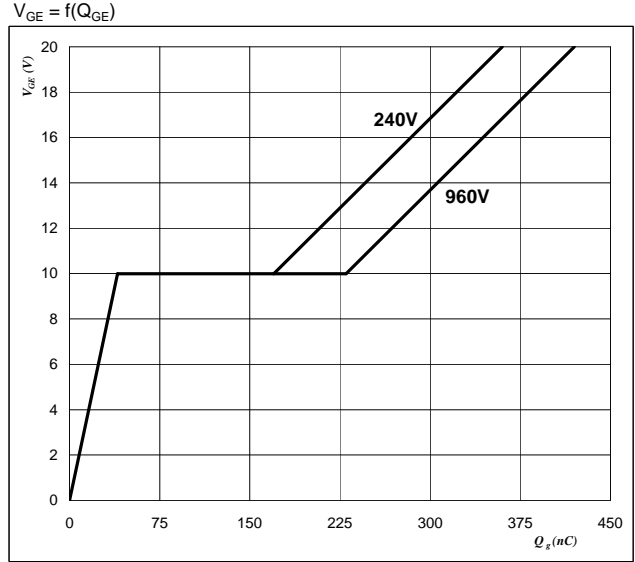
Safe operating area as a function of collector-emitter voltage  
 $I_C = f(V_{CE})$



At  
 D = single pulse  
 $T_h = 80 \text{ } ^\circ\text{C}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $T_j = T_{jmax} \text{ } ^\circ\text{C}$

Figure 26 T1,T2,T3,T4,T5,T6 IGBT

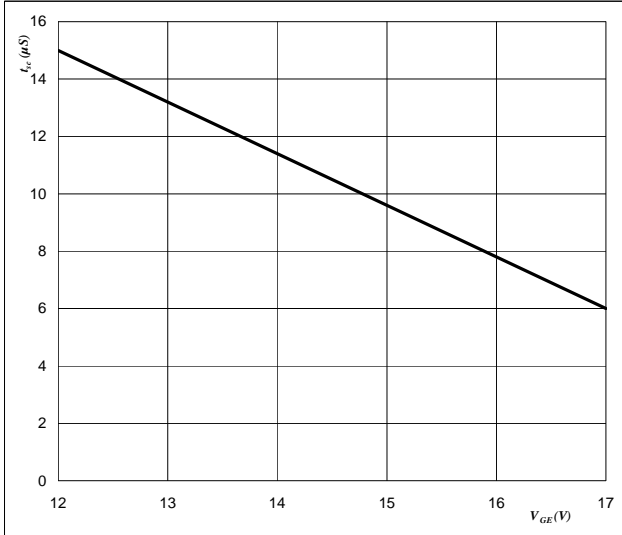
Gate voltage vs Gate charge



At  
 $I_C = 50 \text{ A}$

Figure 27 T1,T2,T3,T4,T5,T6 IGBT

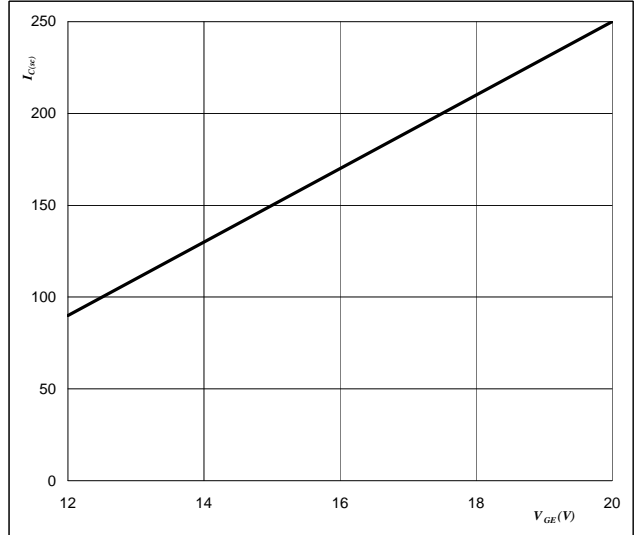
Short circuit withstand time as a function of gate-emitter voltage  
 $t_{sc} = f(V_{GE})$



At  
 $V_{CE} = 1200 \text{ V}$   
 $T_j \leq 150 \text{ } ^\circ\text{C}$

Figure 28 T1,T2,T3,T4,T5,T6 IGBT

Typical short circuit collector current as a function of gate-emitter voltage  
 $V_{GE} = f(Q_{GE})$



At  
 $V_{CE} \leq 1200 \text{ V}$   
 $T_j = 150 \text{ } ^\circ\text{C}$

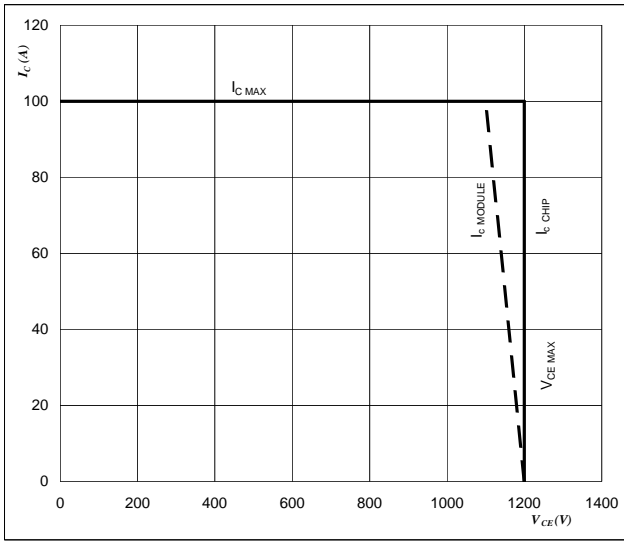


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Figure 29 T1,T2,T3,T4,T5,T6 IGBT

## Reverse bias safe operating area

$I_C = f(V_{CE})$



At

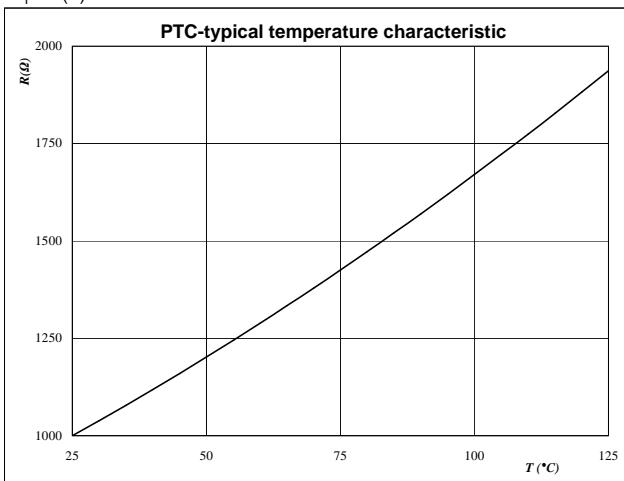
T<sub>J</sub> = T<sub>Jmax</sub>-25 °C  
Switching mode : 3 level switching

## Thermistor

Figure 1 Thermistor

### Typical PTC characteristic as a function of temperature

$R_T = f(T)$



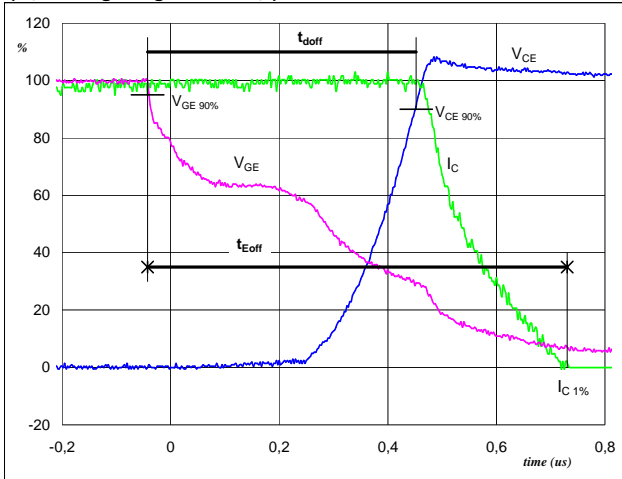


## Switching Definitions Output inverter

General conditions	
$T_j$	= 125 °C
$R_{gon}$	= 18 Ω
$R_{goff}$	= 18 Ω

Figure 1 Output inverter IGBT

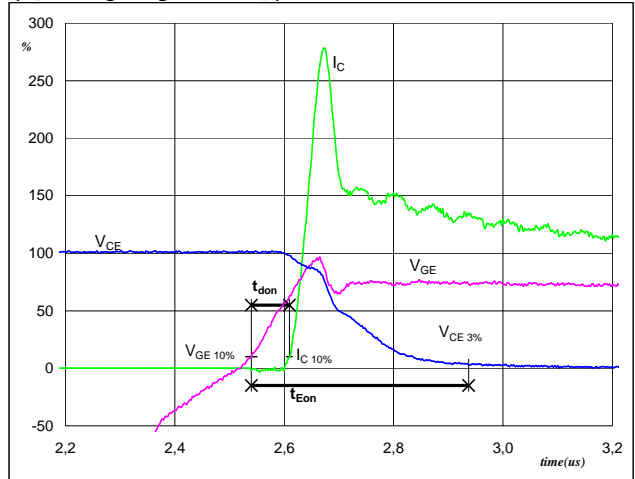
Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$   
( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	49	A
$t_{doff} =$	0,49	μs
$t_{Eoff} =$	0,77	μs

Figure 2 Output inverter IGBT

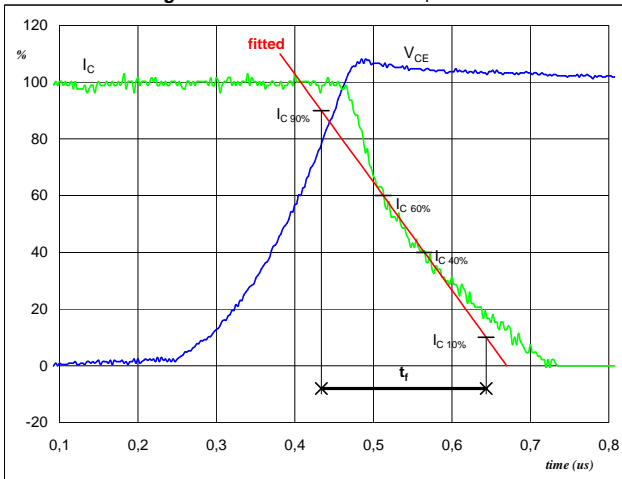
Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$   
( $t_{Eon}$  = integrating time for  $E_{on}$ )



$V_{GE}(-100\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	49	A
$t_{don} =$	0,07	μs
$t_{Eon} =$	0,40	μs

Figure 3 Output inverter IGBT

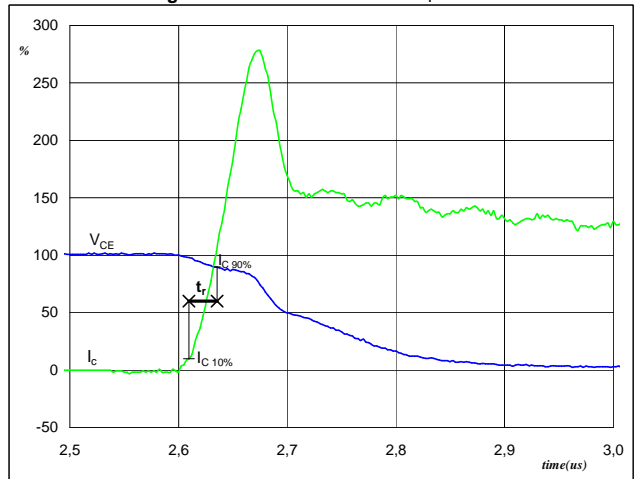
Turn-off Switching Waveforms & definition of  $t_f$



$V_C(100\%) =$	600	V
$I_C(100\%) =$	49	A
$t_f =$	0,21	μs

Figure 4 Output inverter IGBT

Turn-on Switching Waveforms & definition of  $t_r$



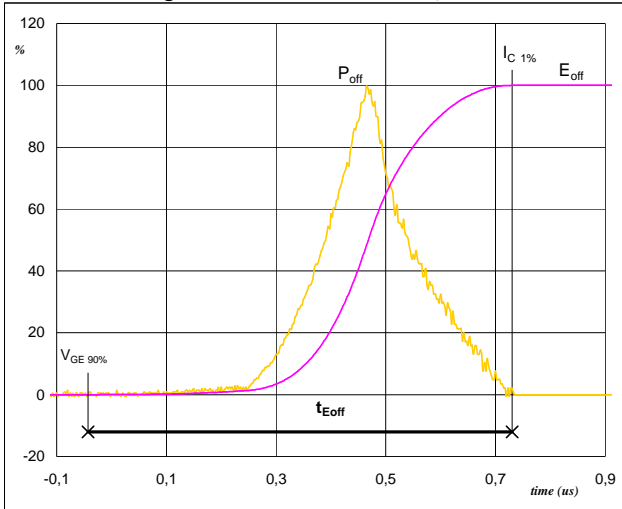
$V_C(100\%) =$	600	V
$I_C(100\%) =$	49	A
$t_r =$	0,02	μs



### Switching Definitions Output inverter

Figure 5 Output inverter IGBT

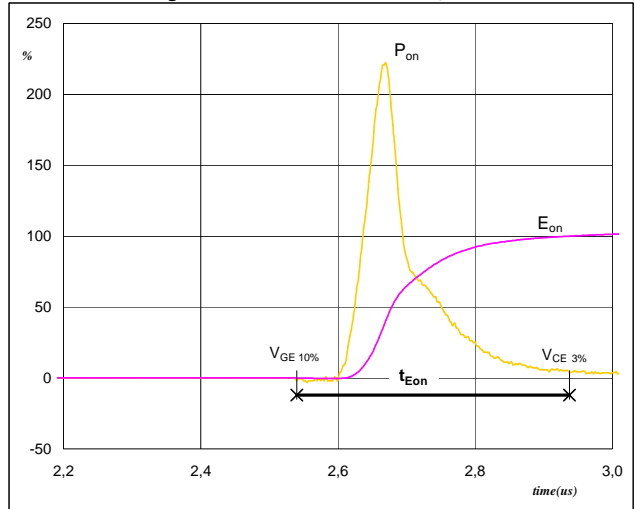
Turn-off Switching Waveforms & definition of  $t_{Eoff}$



$P_{off} (100\%) =$	29,68	kW
$E_{off} (100\%) =$	5,47	mJ
$t_{Eoff} =$	0,77	$\mu$ s

Figure 6 Output inverter IGBT

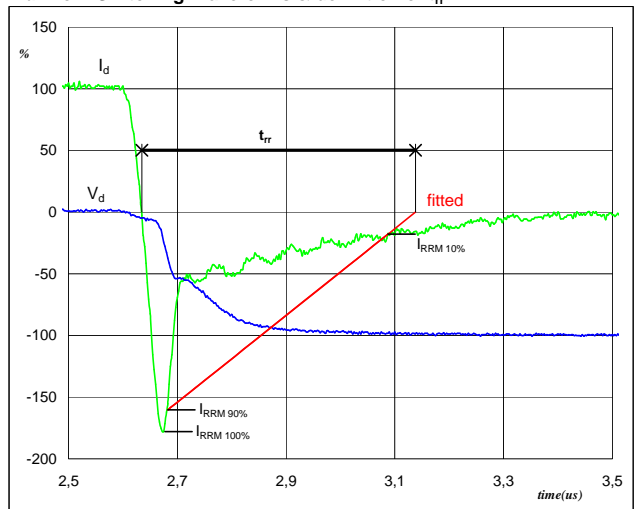
Turn-on Switching Waveforms & definition of  $t_{Eon}$



$P_{on} (100\%) =$	29,68	kW
$E_{on} (100\%) =$	5,40	mJ
$t_{Eon} =$	0,40	$\mu$ s

Figure 7 Output inverter FWD

Turn-off Switching Waveforms & definition of  $t_{rr}$



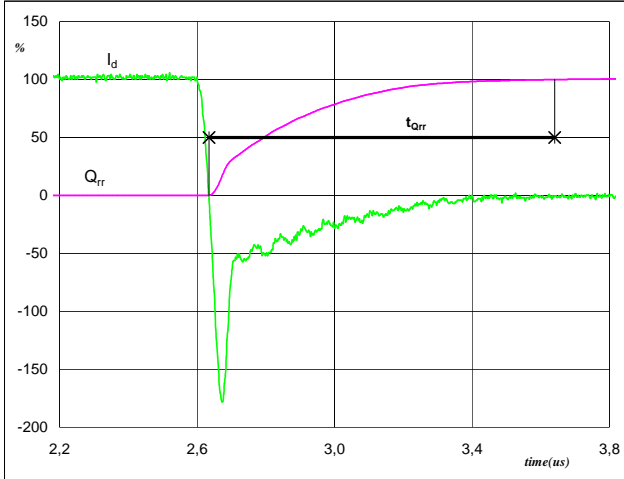
$V_d (100\%) =$	600	V
$I_d (100\%) =$	49	A
$I_{RRM} (100\%) =$	88	A
$t_{rr} =$	0,45	$\mu$ s



### Switching Definitions Output inverter

Figure 8 Output inverter FWD

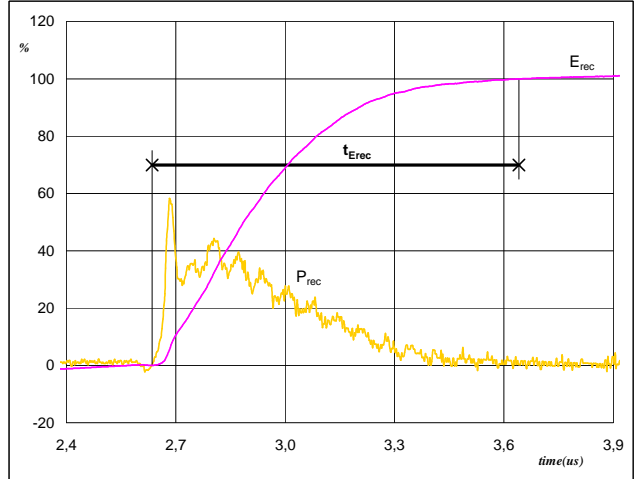
Turn-on Switching Waveforms & definition of  $t_{Qrr}$   
( $t_{Qrr}$  = integrating time for  $Q_{rr}$ )



$I_d$ (100%) =	49	A
$Q_{rr}$ (100%) =	12,20	$\mu C$
$t_{Qrr}$ =	1,01	$\mu s$

Figure 9 Output inverter FWD

Turn-on Switching Waveforms & definition of  $t_{Erec}$   
( $t_{Erec}$  = integrating time for  $E_{rec}$ )



$P_{rec}$ (100%) =	29,68	kW
$E_{rec}$ (100%) =	4,97	mJ
$t_{Erec}$ =	1,01	$\mu s$

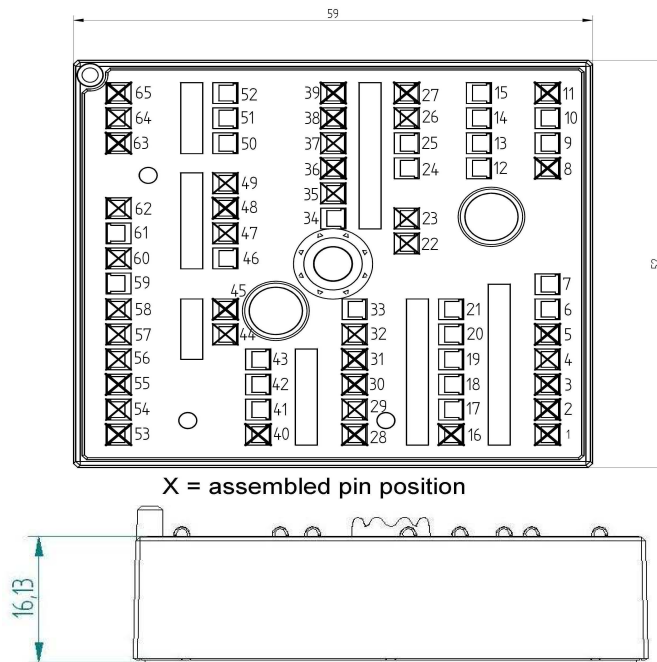


### Ordering Code and Marking - Outline - Pinout

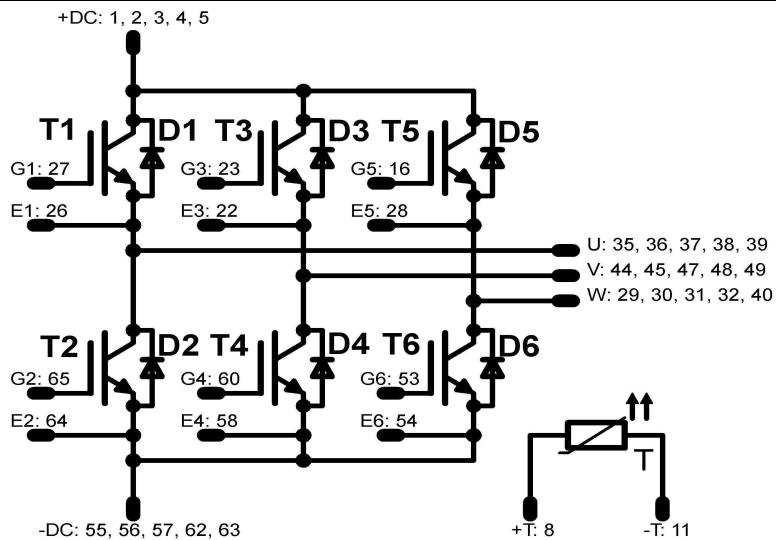
#### Ordering Code & Marking

Version	Ordering Code	in DataMatrix as	in packaging barcode as
with std lid (black V23990-K22-T-PM)	V23990-K239-F-/0A/-PM	K239F	K239F-/0A/
with std lid (black V23990-K22-T-PM) and P12	V23990-K239-F-/1A/-PM	K239F	K239F-/1A/
with thin lid (white V23990-K23-T-PM)	V23990-K239-F-/0B/-PM	K239F	K239F-/0B/
with thin lid (white V23990-K23-T-PM) and P12	V23990-K239-F-/1B/-PM	K239F	K239F-/1B/

#### Outline



#### Pinout





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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.